

Description

The CSD17578Q3A uses advanced trench technology

to provide excellent $R_{\text{DS}(\text{ON})},$ low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

General Features

V_{DS} = 30V I_D =60 A

 $R_{DS(ON)} < 8 \, m\Omega$ @ V_{GS}=10V

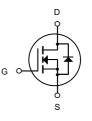
Application

Battery protection

Load switch Uninterruptible power supply







N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
CSD17578Q3A	DFN3X3-8L	HXY MOSFET	5000

Absolute Maximum Ratings (TC=25°C unless otherwise specified)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	30	V
Vgs	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	60	А
I⊳@Tc=100°C	Continuous Drain Current, V _{GS} @ 10V ¹	20	А
Ідм	Pulsed Drain Current ²	140	А
EAS	Single Pulse Avalanche Energy ³	115.2	mJ
las	Avalanche Current	48	А
P _D @T _C =25°C	Total Power Dissipation ⁴	59	W
Тятд	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R ₀ JA	Thermal Resistance Junction-ambient ¹ 62		°C/W
R _θ JC	Thermal Resistance Junction-Case ¹	2.1	°C/W



Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
∆BV _D ss/∆TJ	BVDSS Temperature Coefficient	Reference to 25°C, I⊳=1mA		0.027		V/°C
		V _{GS} =10V , I _D =20A		6	8	
Rds(on)	Static Drain-Source On- Resistance ²	V _{GS} =4.5V , I _D =10A		7.5	10	mΩ
VGS(th)	Gate Threshold Voltage		1.2		2.5	V
$\Delta V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	V _{GS} =V _{DS} , I _D =250uA		-5.8		mV/°C
loss	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	uA
1022	Diam-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55°C			5	uA
lgss	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =30A		43		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.7		Ω
Qg	Total Gate Charge (4.5V)			20		nC
Qgs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =15A		7.6		
Q_gd	Gate-Drain Charge			7.2		
Td(on)	Turn-On Delay Time	-V _{DD} =15V , V _{GS} =10V , -R _G =3.3Ω		7.8		
Tr	Rise Time			15		
Td(off)	Turn-Off Delay Time			37.3		ns
T _f	Fall Time	_I _D =15A		10.6		
Ciss	Input Capacitance			2295		
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V ,		267		pF
Crss	Reverse Transfer Capacitance	f=1MHz		210		
ls	Continuous Source Current ^{1,6}	V _G =V _D =0V , Force			40	А
lsм	Pulsed Source Current ^{2,6}	Current			140	А
Vsd	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1	V

Electrical Characteristics (T_A=25°C unless otherwise noted)

Diode Characteristics

Note :

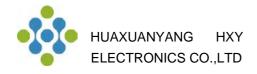
1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3 .The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, \text{L=}0.1\text{mH}, \text{I}_{\text{AS}}\text{=}34\text{A}$

4.The power dissipation is limited by 150 $^\circ\text{C}$ junction temperature

5 .The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.



CSD17578Q3A N-Channel Enhancement Mode MOSFET

Typical Characteristics

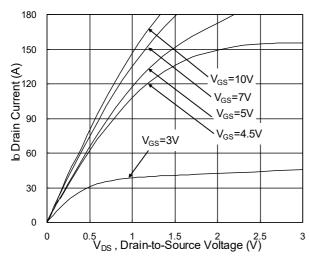


Fig.1 Typical Output Characteristics

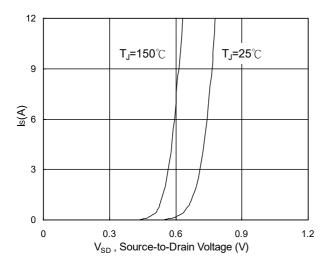


Fig.3 Forward Characteristics of Reverse

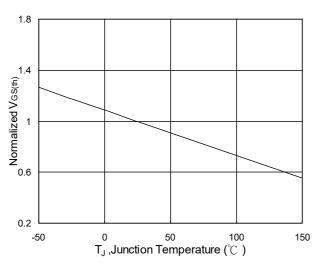


Fig.5 Normalized $V_{\text{GS}(\text{th})}$ vs. T_J

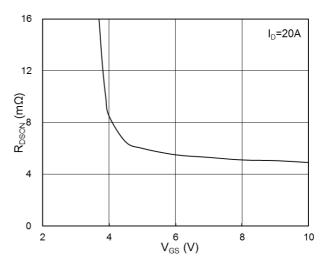


Fig.2 On-Resistance vs. G-S Voltage

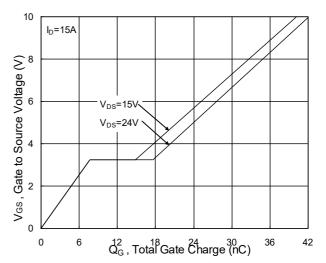


Fig.4 Gate-Charge Characteristics

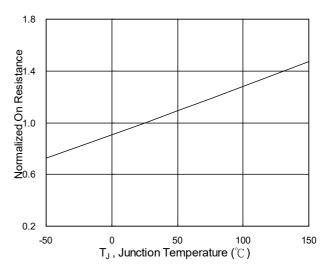
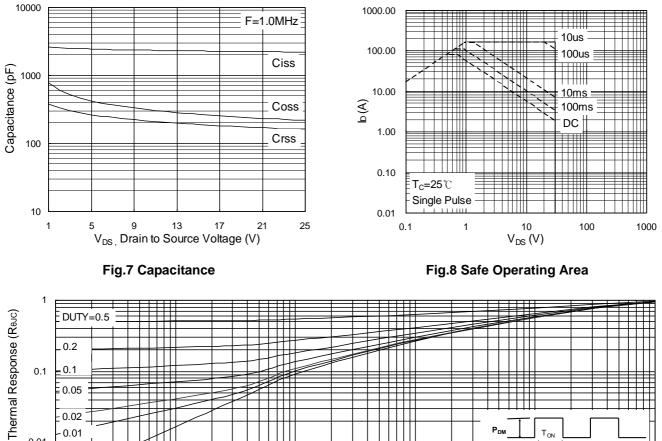
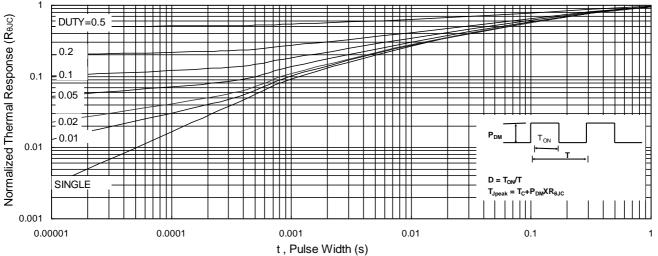


Fig.6 Normalized R_{DSON} vs. T_J









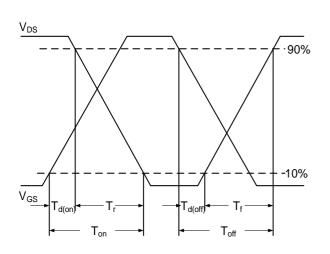
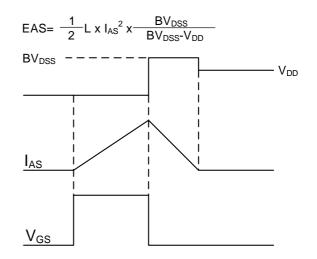
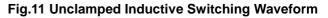


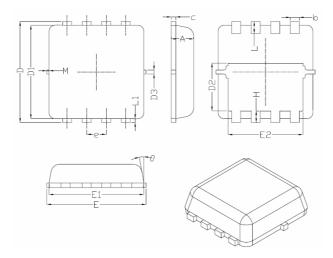
Fig.10 Switching Time Waveform







DFN3X3-8L Package Information



	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
c	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
e	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
Μ	*	*	0.15	
θ		10 [°]	12 [°]	



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